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sector #3

BOX MISSING PARTS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S): Yoshiyuki Yanagisawa, et al. ATTY. DOCKET NO. 09792909-5046

SERIAL NO. 09/876,290 GROUP ART UNIT: 2812

DATE FILED: June 7, 2001 EXAMINER:

INVENTION: "ASSEMBLY JIG AND MANUFACTURING METHOD OF
MULTILAYER SEMICONDUCTOR DEVICE"

SUBMISSION OF MISSING PARTS OF APPLICATION

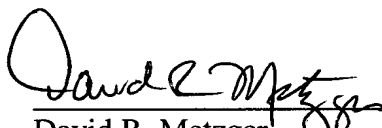
Assistant Commissioner of Patents
Washington, D.C. 20231

S I R:

In response to the Notice to File Missing Parts dated August 7, 2001, the undersigned submits an executed Oath and Declaration as executed by the inventor(s) on September 3, 4 and 7 2001.

A check in the amount of \$130.00 to cover the submission fee is enclosed. However, the Commissioner is authorized to charge any deficiencies or credit any overpayments to Deposit Account No. 19-3140. A duplicate copy of this sheet is enclosed for that purpose.

Respectfully submitted,

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CERTIFICATE OF MAILING

I hereby certify that a true copy of the foregoing Submission of Missing Parts was forwarded to the United States Patent Office via U.S. First Class mail on September 27, 2001.

